



Product Change Notification

108915 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 108915 - 00
Change Title: DG45ID, PCN 108915-00, Product Material, Capacitor change
Date of Publication: October 15, 2008

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Oct 16, 2008
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Description of Change to the Customer:

The 100 uF capacitors at locations EC1, EC2, EC12, EC18, EC26, EC31, EC32, EC33, EC79, EC489, and EC490 will be changed from protuberant to flat for placement to improve manufacturability.

The 220 uF capacitors at locations EC3, EC4, EC13, and C34 will be changed from protuberant to flat for placement to improve manufacturability.

The 470 uF capacitors at locations EC7, EC9, EC10, EC16, EC20, EC21, EC22, EC23, EC24, and EC25 will be changed from protuberant to flat for placement to improve manufacturability.

Customer Impact of Change and Recommended Action:

This change has been thoroughly evaluated to ensure that there are no quality, reliability or functional implications to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change AA	Post Change AA
BLKDG45ID 895894	895894	E27729-307	E27729-308
BOXDG45ID 895987	895987	E27729-307	E27729-308

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
October 15, 2008	00	Originally Published PCN